FORM PTO-1595 (Rev. 6-93)

**RECC** 

03-07-2001



101627436

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

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	Attorney Docket No.: 040894-5628	
To the Commissioner for Patents: Please record the attached original documents or copy thereof.	ATTN: BOX ASSIGNMENT	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):	
Takuya KITAMURA	Name: MAX CO., LTD.	
Additional name(s) of conveying party(ies) attached?  YesX_ No	Internal Address:	
3. Nature of conveyance:	Street Address: 6-6, Nihonbashi Hakozaki-cho, Chuo-ku, Tokyo Japan	
X Assignment Merger Security Agreement Change of Name Other	City: State: Zip:	
Execution Date: January 30, 2001	Additional name(s) & address(es) attached?  Yes _X No	
<ul> <li>4. Application number(s) or patent number(s):</li> <li>If this document is being filed together with a new application the ex</li></ul>		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: George F. Lesmes  Internal Address: Morgan, Lewis & Bockius LLP Customer No. 009629	7. Total fee (37 C.F.R §3.41):\$40.00X_ Enclosed Authorized to be charged to deposit account 50-0310	
Street Address: 1800 M Street, N.W. City: Washington State: D.C. Zip: 20036	Deposit account number: 50-0310     Attach duplicate of page if paying by deposit account	
9. Statement and Signature		
To the best of my knowledge and belief, the foregoing information the original document.  George F. Lesmes  Name of Person Signing  Rep # 1999 Signature	February 2, 2001 Date	
/05/2001 TDIAZ1 00000036 09773515    Total number of pages including cover sheet, attachments and documents: _2		

## **ASSIGNMENT**

entitled:  STAPLE JUMP PREVENTING MECHANISM FOR STAPLE CARTRIDGE		
for which I/WE executed an application for United States Letters Patent concurrently herewith; or on; or filed an application for United States Letters Patent on, (Serial No); and		
WHEREAS, MAX Co., LTD.  a corporation of Japan  Hakozaki-cho, Chuo-ku, Tokyo, Japan  is desirous of securing the entire right, title, and intere  Patent on this invention and the Letters Patent to be is	st in and to this invention, the application	after referred to as Assignee),
NOW THEREFORE, be it known that, for go hereby acknowledged, I/WE, as assignor(s), have sold, and set over unto the assignee, its lawful successors an invention and this application, and all divisions, and comay be granted thereon, and all reissues thereof; and I Irademarks of the United States to issue all Letters Paraccordance with the terms of this Assignment;	assigned, transferred, and set over, and d assigns, MY/OUR entire right, title, as ntinuations thereof, and all Letters Paten /WE hereby authorize and request the O	do hereby sell, assign, transfer, and interest in and to this at of the United States which Commissioner of Patents and
AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with issignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect he title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to he execution of such papers shall be borne by the assignee, its successors and assigns.		
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No, filed brunny 2,200) he filing date and application number of said application when known.  IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).		
Full Name of Sole of First Assignor     Takuya KITAMURA	Assignor's Signature Takuya Kitamuru	Date January 30, 2001
Address c/o MAX Co., LTD., 6-6, Nihonbashi Hakozaki-cho, Chuo-ku, Tokyo, Japan		Citizenship Japan
2. Full Name of Second Assignor	Assignor's Signature	Date
Address	<del></del>	Citizenship

MORGAN, LEWIS & BOCKIUS

**RECORDED: 02/02/2001** 

PATENT REEL: 011548 FRAME: 0412